

## General Description

The CD4043 is a quad R/S latch with 3-state outputs with a common output enable input (OE). Each latch has an active HIGH set input (1S to 4S), an active HIGH reset input (1R to 4R) and an active HIGH 3-state output (1Q to 4Q).

When OE is HIGH, the latch output (nQ) is determined by the nR and nS inputs as shown in function table. When OE is LOW, the latch outputs are in the high impedance OFF-state. OE does not affect the state of the latch. The high impedance off-state feature allows common bussing of the outputs.

It operates over a recommended  $V_{DD}$  power supply range of 3V to 15V referenced to  $V_{SS}$  (usually ground). Unused inputs must be connected to  $V_{DD}$ ,  $V_{SS}$ , or another input.

## Features

- 5V, 10V, and 15V parametric ratings
- Standardized symmetrical output characteristics
- Specified from  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$
- Packaging information: DIP16/SOP16/TSSOP16

## ORDERING INFORMATION

DEVICE	Package Type	MARKING	Packing	Packing QTY
CD4043BE	DIP-16	CD4043BE	Tube	1000/Box
CD4043BDTR	SOP-16	CD4043B	Tape	2500/Reel
CD4043BTDTR	TSSOP-16	CD4043B	Tape	3000/Reel

## Block Diagram And Pin Description

### Block Diagram

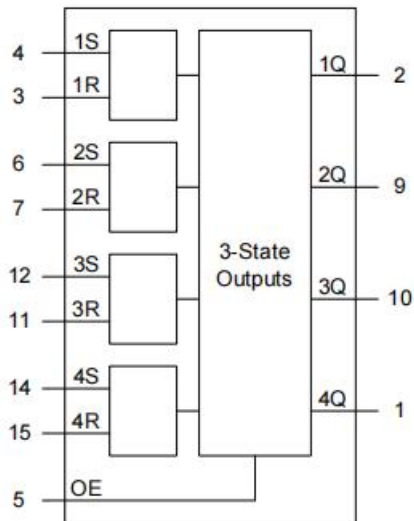


Figure 1. Functional diagram

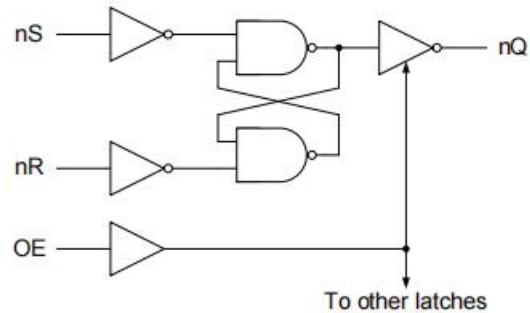
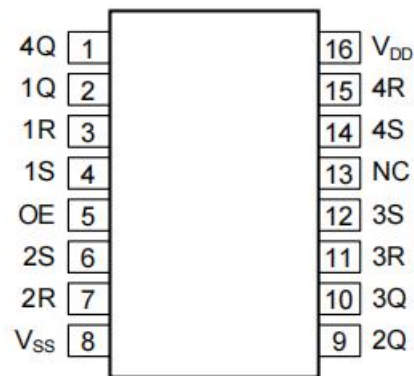


Figure 2. Logic diagram for one latch

### Pin Configurations



Pin Description

Pin No.	Pin Name	Description
1	4Q	3-state buffered latch output
2	1Q	3-state buffered latch output
3	1R	reset input(active HIGH)
4	1S	set input (active HIGH)
5	OE	common output enable input
6	2S	set input(active HIGH)
7	2R	reset input(active HIGH)
8	V <sub>SS</sub>	ground supply voltage
9	2Q	3-state buffered latch output
10	3Q	3-state buffered latch output
11	3R	reset input(active HIGH)
12	3S	set input(active HIGH)
13	NC	not connected
14	4S	set input(active HIGH)
15	4R	reset input(active HIGH)
16	V <sub>DD</sub>	supply voltage

Function Table

Inputs			Output
OE	nS	nR	nQ
L	X	X	Z
H	L	H	L
H	H	X	H
H	L	L	latched

Note: [1] H=HIGH voltage level; L=LOW voltage level; X=don't care; Z=high impedance state.

## Electrical Parameter

### Absolute Maximum Ratings

Parameter	Symbol	Conditions	Min.	Max.	Unit
supply voltage	$V_{DD}$		-0.5	+18	V
input clamping current	$I_{IK}$	$V_I < -0.5V$ or $V_I > V_{DD}+0.5V$	-	$\pm 10$	mA
input voltage	$V_I$		-0.5	$V_{DD}+0.5$	V
output clamping current	$I_{OK}$	$V_O < -0.5V$ or $V_O > V_{DD}+0.5V$	-	$\pm 10$	mA
output current	$I_O$	$V_O=0V$ to $V_{CC}$	-	$\pm 10$	mA
supply current	$I_{DD}$	-	-	50	mA
total power dissipation	$P_{tot}$	-	-	500	mW
power dissipation	$P_D$	per output	-	100	mW
storage temperature	$T_{Tsg}$	-	-65	+150	°C
soldering temperature	$T_L$	10s	DIP	245	°C
			SOP	260	°C

### Recommended Operating Conditions

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
supply voltage	$V_{DD}$	-	3	-	15	V
input voltage	$V_I$	-	0	-	$V_{DD}$	V
operating temperature	$T_{amb}$	-	-40	-	+85	°C

## Electrical Characteristics

DC Characteristics 1 (T<sub>amb</sub>=25°C, voltages are referenced to V<sub>SS</sub> (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions(V)			T <sub>amb</sub> =25°C			Unit
		V <sub>O</sub>	V <sub>IN</sub>	V <sub>DD</sub>	Min.	Typ.	Max.	
supply current	I <sub>DD</sub>	-	0, 5	5	-	-	20	μA
		-	0, 10	10	-	-	40	μA
		-	0, 15	15	-	-	80	μA
LOW-level output current	I <sub>OL</sub>	0.4	0, 5	5	0.44	-	-	mA
		0.5	0, 10	10	1.1	-	-	mA
		1.5	0, 15	15	3.0	-	-	mA
HIGH-level output current	I <sub>OH</sub>	4.6	0, 5	5	-	-	-0.44	mA
		2.5	0, 5	5	-	-	-1.4	mA
		9.5	0, 10	10	-	-	-1.1	mA
		13.5	0, 15	15	-	-	-3.0	mA
LOW-level output voltage	V <sub>OL</sub>	-	0, 5	5	-	-	0.05	V
		-	0, 10	10	-	-	0.05	V
		-	0, 15	15	-	-	0.05	V
HIGH-level output voltage	V <sub>OH</sub>	-	0, 5	5	4.95	-	-	V
		-	0, 10	10	9.95	-	-	V
		-	0, 15	15	14.95	-	-	V
LOW-level input voltage	V <sub>IL</sub>	0.5, 4.5	-	5	-	-	1.5	V
		1, 9	-	10	-	-	3	V
		1.5, 13.5	-	15	-	-	4	V
HIGH-level input voltage	V <sub>IH</sub>	0.5, 4.5	-	5	3.5	-	-	V
		1, 9	-	10	7	-	-	V
		1.5, 13.5	-	15	11	-	-	V
input leakage current	I <sub>I</sub>	-	0, 15	15	-	-	±1.0	μA
OFF-state output current	I <sub>OZ</sub>	nQ output HIGH; returned to V <sub>DD</sub>		15	-	-	1.6	μA
		nQ output LOW; returned to V <sub>SS</sub>		15	-	-	1.6	μA
input capacitance	C <sub>I</sub>	-	-	-	-	-	7.5	pF

DC Characteristics 2

(T<sub>amb</sub>=-40°C to +85°C, voltages are referenced to V<sub>SS</sub> (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions(V)			T <sub>amb</sub> =-40°C		T <sub>amb</sub> =+85°C		Unit
		V <sub>O</sub>	V <sub>IN</sub>	V <sub>DD</sub>	Min.	Max.	Min.	Max.	
supply current	I <sub>DD</sub>	-	0, 5	5	-	20	-	150	μA
		-	0, 10	10	-	40	-	300	μA
		-	0, 15	15	-	80	-	600	μA
LOW-level output current	I <sub>OL</sub>	0.4	0, 5	5	0.52	-	0.36	-	mA
		0.5	0, 10	10	1.3	-	0.9	-	mA
		1.5	0, 15	15	3.6	-	2.4	-	mA
HIGH-level output current	I <sub>OH</sub>	4.6	0, 5	5	-	-0.52	-	-0.36	mA
		2.5	0, 5	5	-	-1.7	-	-1.1	mA
		9.5	0, 10	10	-	-1.3	-	-0.9	mA
		13.5	0, 15	15	-	-3.6	-	-2.4	mA
LOW-level output voltage	V <sub>OL</sub>	-	0, 5	5	-	0.05	-	0.05	V
		-	0, 10	10	-	0.05	-	0.05	V
		-	0, 15	15	-	0.05	-	0.05	V
HIGH-level output voltage	V <sub>OH</sub>	-	0, 5	5	4.95	-	4.95	-	V
		-	0, 10	10	9.95	-	9.95	-	V
		-	0, 15	15	14.95	-	14.95	-	V
LOW-level input voltage	V <sub>IL</sub>	0.5, 4.5	-	5	-	1.5	-	1.5	V
		1, 9	-	10	-	3	-	3	V
		1.5, 13.5	-	15	-	4	-	4	V
HIGH-level input voltage	V <sub>IH</sub>	0.5, 4.5	-	5	3.5	-	3.5	-	V
		1, 9	-	10	7	-	7	-	V
		1.5, 13.5	-	15	11	-	11	-	V
input leakage current	I <sub>I</sub>	-	0, 15	15	-	±0.1	-	±1.0	μA
OFF-state output current	I <sub>OZ</sub>	nQ output HIGH; returned to V <sub>DD</sub>		15	-	1.6	-	12	μA
		nQ output LOW; returned to V <sub>SS</sub>		15	-	1.6	-	12	μA

AC Characteristics ( $T_{amb}=25^{\circ}\text{C}$ ,  $V_{SS}=0\text{V}$ , unless otherwise specified.)

Parameter	Symbol	Conditions	VDD	Min.	Typ.	Max.	Unit
HIGH to LOW propagation delay	$t_{PHL}$	nR→nQ; see Figure 4	5 <sup>[1]</sup>	-	90	180	ns
			10	-	35	70	ns
			15	-	25	50	ns
LOW to HIGH propagation delay	$t_{PLH}$	nS→nQ; see Figure 4	5 <sup>[1]</sup>	-	65	135	ns
			10	-	25	50	ns
			15	-	15	35	ns
transition time	$t_{THL}, t_{TLH}$	nQ output; see Figure 4	5 <sup>[1][2]</sup>	-	60	120	ns
			10	-	30	60	ns
			15	-	30	60	ns
HIGH to OFF-state propagation delay	$t_{PHZ}$	OE→nQ; see Figure 5	5	-	45	90	ns
			10	-	25	50	ns
			15	-	20	40	ns
LOW to OFF-state propagation delay	$t_{PLZ}$	OE→nQ; see Figure 5	5	-	50	100	ns
			10	-	20	40	ns
			15	-	15	30	ns
OFF-state to HIGH propagation delay	$t_{PZH}$	OE→nQ; see Figure 5	5	-	40	80	ns
			10	-	26	60	ns
			15	-	25	50	ns
OFF-state to LOW propagation delay	$t_{PZL}$	OE→nQ; see Figure 5	5	-	45	90	ns
			10	-	30	60	ns
			15	-	30	60	ns
pulse width	$t_w$	nS input HIGH; minimum width; see Figure 4	5	30	15	-	ns
			10	20	10	-	ns
			15	16	8	-	ns
		nR input HIGH; minimum width; see Figure 4	5	30	15	-	ns
			10	20	10	-	ns
			15	16	8	-	ns

Note:

The typical values of the propagation delay and transition times are calculated from the extrapolation formulas shown ( $C_L$  in pF).

## Testing Circuit

### AC Testing Circuit

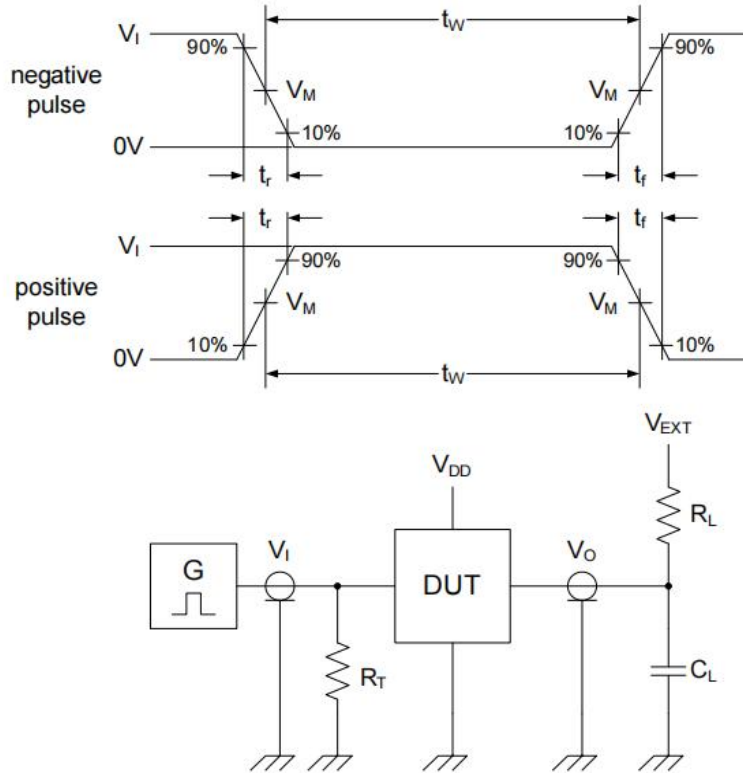


Figure 3. Test circuit for switching times

Definitions for test circuit:

DUT=Device Under Test

$C_L$ =Load capacitance including jig and probe capacitance.

$R_T$ =Termination resistance should be equal to the output impedance  $Z_o$  of the pulse generator.

$V_{EXT}$ =External voltage for measuring switching times.



AC Testing Waveforms

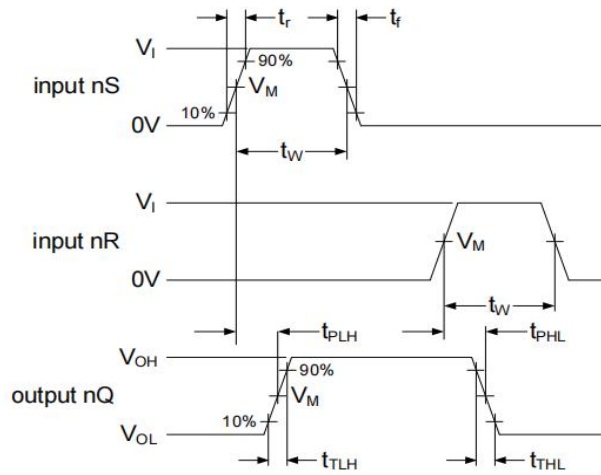


Figure 4. Input minimum set (nS) and reset (nR) pulse widths, inputs nS or nR to latch output (nQ) propagation delay and nQ transition time

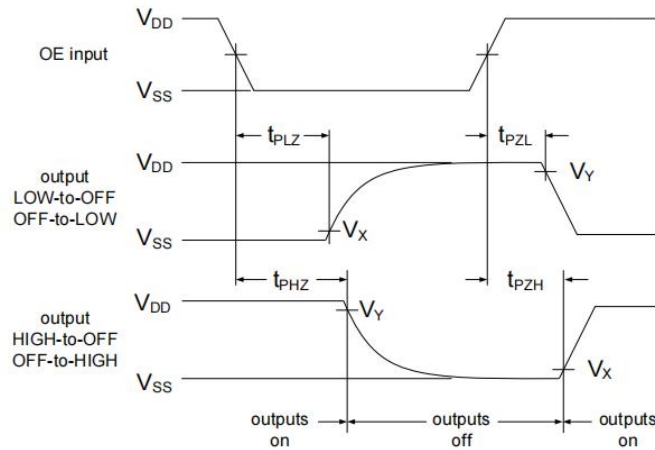


Figure 5. Output enable (OE) to latch output (nQ) enable time ( $t_{PZL}$  and  $t_{PZH}$ ) and disable time ( $t_{PLZ}$  and  $t_{PHZ}$ )

Measurement Points

Supply voltage	Input		Output		
$V_{DD}$	$V_I$	$V_M$	$V_M$	$V_X$	$V_Y$
5V to 15V	$V_{DD}$ or 0V	$0.5 \times V_{DD}$	$0.5 \times V_{DD}$	$0.1 \times V_{DD}$	$0.9 \times V_{DD}$

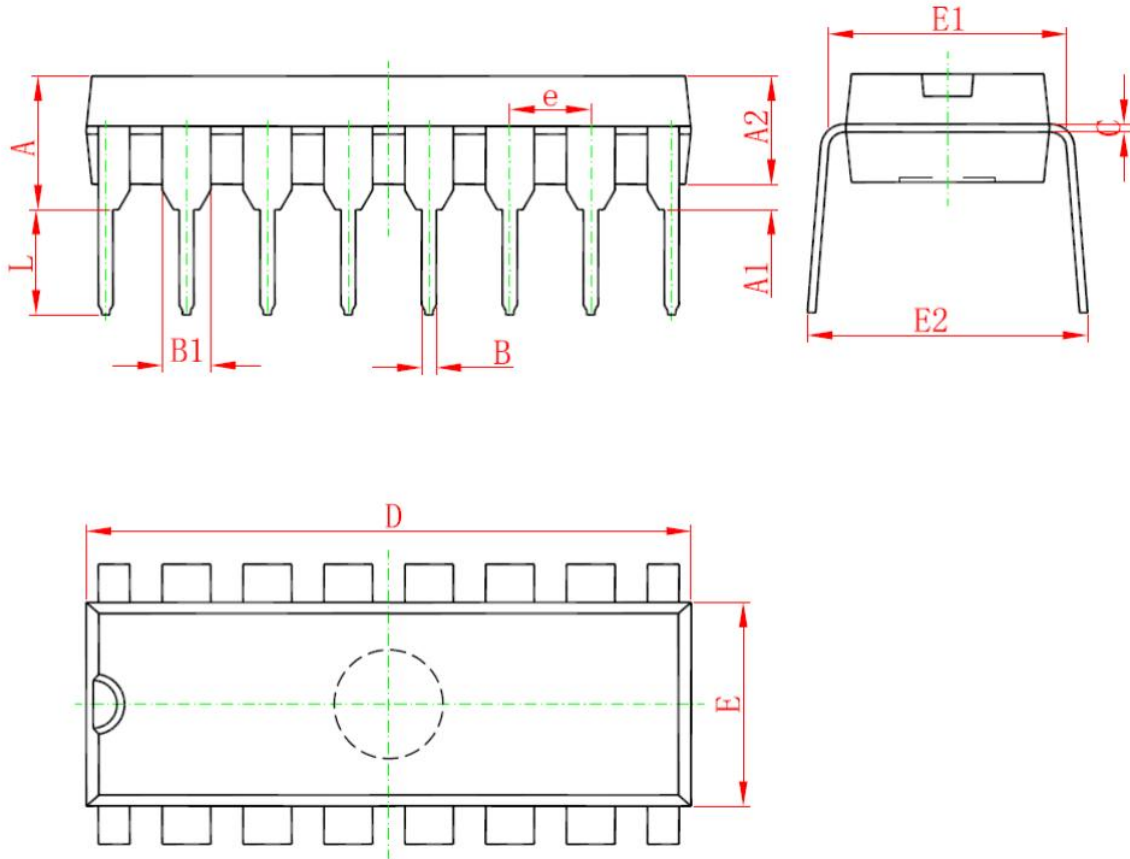
Test Data

Supply voltage	Input		Load		$V_{EXT}$		
$V_{DD}$	$V_I$	$t_r, t_f$	$C_L$	$R_L$	$t_{PLH}, t_{PHL}$	$t_{PLZ}, t_{PZL}$	$t_{PHZ}, t_{PZH}$

5V to 15V	V <sub>DD</sub>	≤20ns	50pF	1KΩ	open	V <sub>DD</sub>	GND
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## Package Information

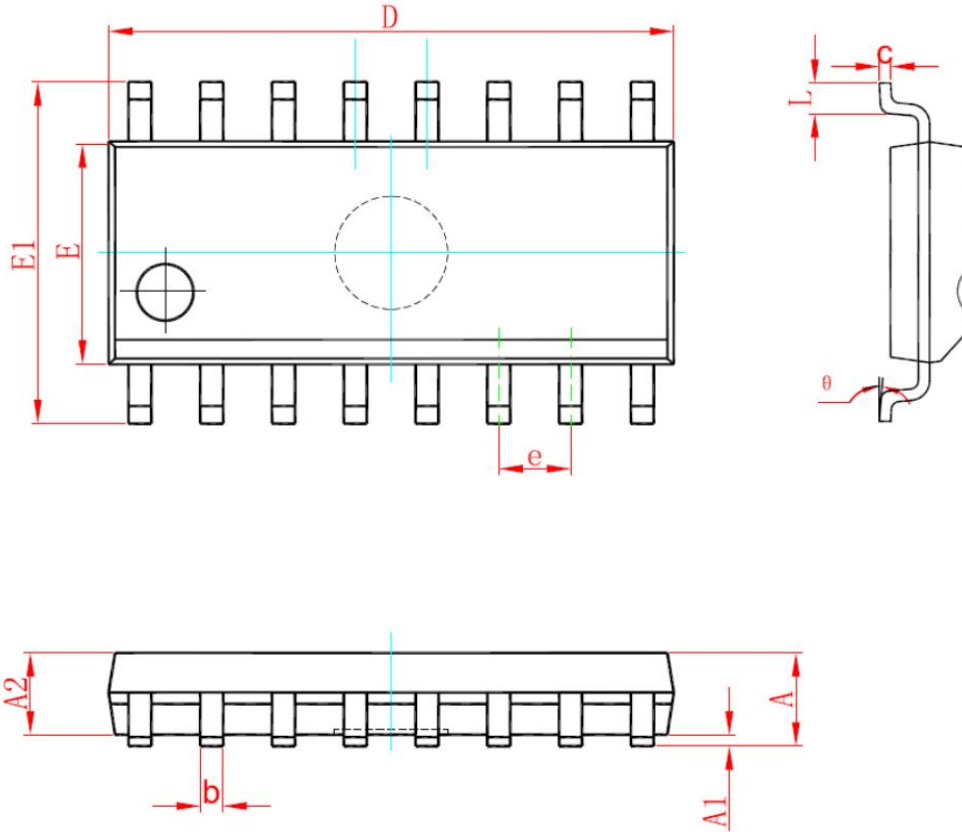
### DIP16



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	3.710	4.310	0.146	0.170
A1	0.510		0.020	
A2	3.200	3.600	0.126	0.142
B	0.380	0.570	0.015	0.022
B1	1.524(BSC)		0.060(BSC)	
C	0.204	0.360	0.008	0.014
D	18.800	19.200	0.740	0.756
E	6.200	6.600	0.244	0.260
E1	7.320	7.920	0.288	0.312
e	2.540(BSC)		0.100(BSC)	

L	3.000	3.600	0.118	0.142
E2	8.400	9.000	0.331	0.354

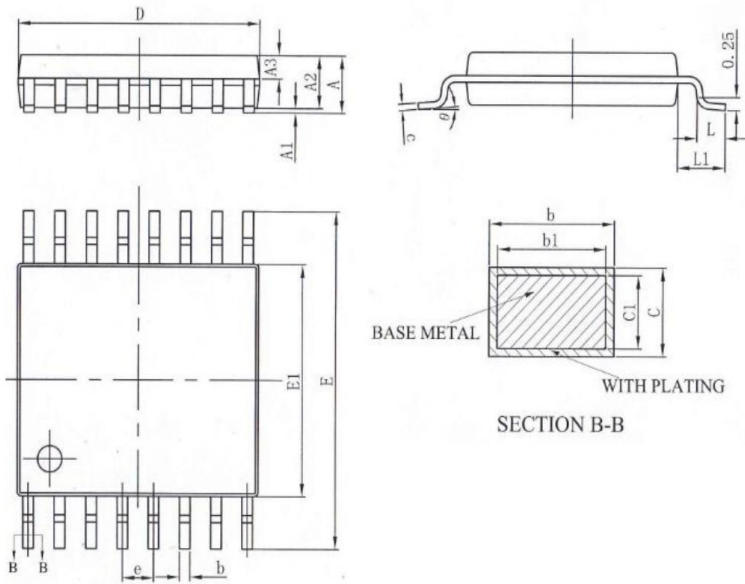
SOP16



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.007	0.010
D	9.800	10.200	0.386	0.402
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050

$\theta$	$0^\circ$	$8^\circ$	$0^\circ$	$8^\circ$
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TSSOP16



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	-	-	1.20
A1	0.05	-	0.15
A2	0.90	1.00	1.05
A3	0.39	0.44	0.49
b	0.20	-	0.28
b1	0.19	0.22	0.25
c	0.13	-	0.17
c1	0.12	0.13	0.14
D	4.90	5.00	5.10
E	6.20	6.40	6.60
E1	4.30	4.40	4.50
e	0.65BSC		
L	0.45	0.60	0.75
L1	1.00BSC		
$\theta$	0	-	$8^\circ$

Statements And Notes

Part name	Hazardous substances or Elements									
	Lead and lead compounds	Mercury and mercury compounds	Cadmium and cadmium compounds	Hexavalent chromium compounds	Polybrominated biphenyls	Polybrominated biphenyl ethers	Dibutyl phthalate	Butyl benzyl phthalate	Di-2-ethylhexyl phthalate	Diisobutyl phthalate
Lead frame	○	○	○	○	○	○	○	○	○	○
Plastic resin	○	○	○	○	○	○	○	○	○	○
Chip	○	○	○	○	○	○	○	○	○	○
The lead	○	○	○	○	○	○	○	○	○	○
Plastic sheet installed	○	○	○	○	○	○	○	○	○	○
explanation	○: Indicates that the content of hazardous substances or elements in the detection limit of the following the SJ/T11363-2006 standard. ×: Indicates that the content of hazardous substances or elements exceeding the SJ/T11363-2006 Standard limit requirements									

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